

STARPOWER

SEMICONDUCTOR™

IGBT

GD50HCK120C5S

Preliminary

Molding Type Module**1200V/50A 4 in one-package**

General Description

STARPOWER IGBT Power Module provides ultrafast switching speed as well as short circuit ruggedness. It's designed for the applications such as electrical welding and inductive heating.



Features

- Low $V_{CE(sat)}$ NPT IGBT technology
- 10 μ s short circuit capability
- $V_{CE(sat)}$ with positive temperature coefficient
- Rugged with ultrafast performance
- Square RBSOA
- Low inductance case
- Fast & soft reverse recovery anti-parallel FWD
- Isolated copper baseplate using DBC technology

Typical Applications

- Switching mode power supplies
- Inductive heating
- Electrical welding

IGBT-inverter $T_C=25^\circ\text{C}$ unless otherwise noted**Maximum Rated Values**

Symbol	Description	GD50HCK120C5S	Units
V_{CES}	Collector-Emitter Voltage @ $T_j=25^\circ\text{C}$	1200	V
V_{GES}	Gate-Emitter Voltage	± 20	V
I_C	Collector Current @ $T_C=25^\circ\text{C}$	100	A
	@ $T_C=80^\circ\text{C}$	50	
I_{CM}	Pulsed Collector Current $t_p=1\text{ms}$	100	A
P_{tot}	Total Power Dissipation @ $T_j=150^\circ\text{C}$	417	W
T_{SC}	Short Circuit Withstand Time @ $T_j=125^\circ\text{C}$	10	μs

Off Characteristics

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$V_{(BR)CES}$	Collector-Emitter Breakdown Voltage	$T_j=25^\circ\text{C}$	1200			V
I_{CES}	Collector Cut-Off Current	$V_{CE}=V_{CES}, V_{GE}=0\text{V}, T_j=25^\circ\text{C}$			1.0	mA
I_{GES}	Gate-Emitter Leakage Current	$V_{GE}=V_{GES}, V_{CE}=0\text{V}, T_j=25^\circ\text{C}$			400	nA

On Characteristics

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$V_{GE(th)}$	Gate-Emitter Threshold Voltage	$I_C=500\mu\text{A}, V_{CE}=V_{GE}, T_j=25^\circ\text{C}$	4.4	5.2	6.0	V
$V_{CE(sat)}$	Collector to Emitter Saturation Voltage	$I_C=50\text{A}, V_{GE}=15\text{V}, T_j=25^\circ\text{C}$		2.15	2.55	V
		$I_C=50\text{A}, V_{GE}=15\text{V}, T_j=125^\circ\text{C}$		2.55		

Switching Characteristics

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units	
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=600\text{V}, I_C=50\text{A}, R_G=22\Omega, V_{GE}=\pm 15\text{V}, T_j=25^\circ\text{C}$		381		ns	
t_r	Rise Time			163		ns	
$t_{d(off)}$	Turn-Off Delay Time			393		ns	
t_f	Fall Time			76		ns	
E_{on}	Turn-On Switching Loss				5.70		mJ
E_{off}	Turn-Off Switching Loss				3.45		mJ
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=600\text{V}, I_C=50\text{A}, R_G=22\Omega, V_{GE}=\pm 15\text{V}, T_j=125^\circ\text{C}$		395		ns	
t_r	Rise Time			76		ns	
$t_{d(off)}$	Turn-Off Delay Time			399		ns	
t_f	Fall Time			265		ns	

E_{on}	Turn-On Switching Loss	$V_{CC}=600V, I_C=50A,$ $R_G=22\Omega, V_{GE}=\pm 15V,$ $T_J=125^\circ C$		6.82		mJ
E_{off}	Turn-Off Switching Loss			4.86		mJ
C_{ies}	Input Capacitance	$V_{CE}=30V, f=1Mhz,$ $V_{GE}=0V$		4.30		nF
C_{oes}	Output Capacitance			0.40		nF
C_{res}	Reverse Transfer Capacitance			0.16		nF
I_{SC}	SC Data	$T_P \leq 10\mu s, V_{GE}=15V,$ $T_J=125^\circ C, V_{CC}=900V,$ $V_{CEM} \leq 1200V$		TBD		A

DIODE-inverter $T_C=25^\circ C$ unless otherwise noted

Maximum Rated Values

Symbol	Description	GD50HCK120C5S	Units
V_{RRM}	Collector-Emitter Voltage @ $T_J=25^\circ C$	1200	V
I_F	DC Forward Current	50	A
I_{FRM}	Repetitive Peak Forward Current $t_p=1ms$	100	A
I^2t	I^2t -value, $V_R=0V, t_p=10ms, T_J=125^\circ C$	1250	A^2s

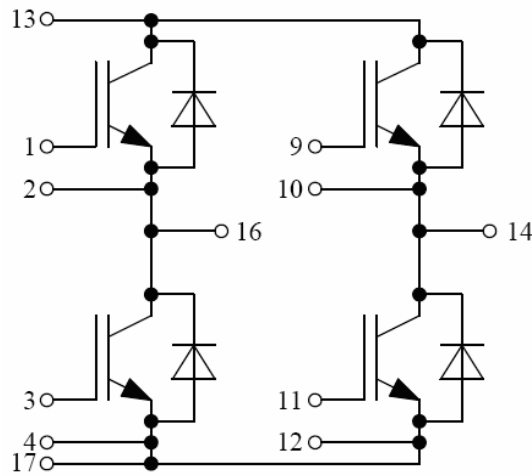
Characteristics Values

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
V_F	Diode Forward Voltage	$I_F=50A, V_{GE}=0V$	$T_J=25^\circ C$	1.82	2.25	V
			$T_J=125^\circ C$	1.95		
Q_r	Recovered Charge	$I_F=50A,$	$T_J=25^\circ C$	3.4		μC
			$T_J=125^\circ C$	6.4		
I_{RM}	Peak Reverse Recovery Current	$V_R=600V,$ $di/dt=-762A/\mu s,$	$T_J=25^\circ C$	35		A
			$T_J=125^\circ C$	44		
E_{rec}	Reverse Recovery Energy	$V_{GE}=-15V$	$T_J=25^\circ C$	1.07		mJ
			$T_J=125^\circ C$	2.26		

IGBT Module

Symbol	Parameter	Min.	Typ.	Max.	Units
V _{ISO}	Isolation Voltage RMS,f=50Hz,t=1min		2500		V
L _{CE}	Stray Inductance		60		nH
R _{CC'+EE'}	Module Lead Resistance,Terminal to Chip @ T _C =25°C		2.5		mΩ
R _{θJC}	Junction-to-Case (per IGBT-inverter) Junction-to-Case (per DIODE-inverter)			0.30 0.49	K/W
R _{θCS}	Case-to-Sink (Conductive grease applied)		0.02		K/W
T _j	Maximum Junction Temperature			150	°C
T _{STG}	Storage Temperature Range	-40		125	°C
Mounting Torque	Mounting Screw:M5	3.0		6.0	N.m
G	Weight of Module		200		g

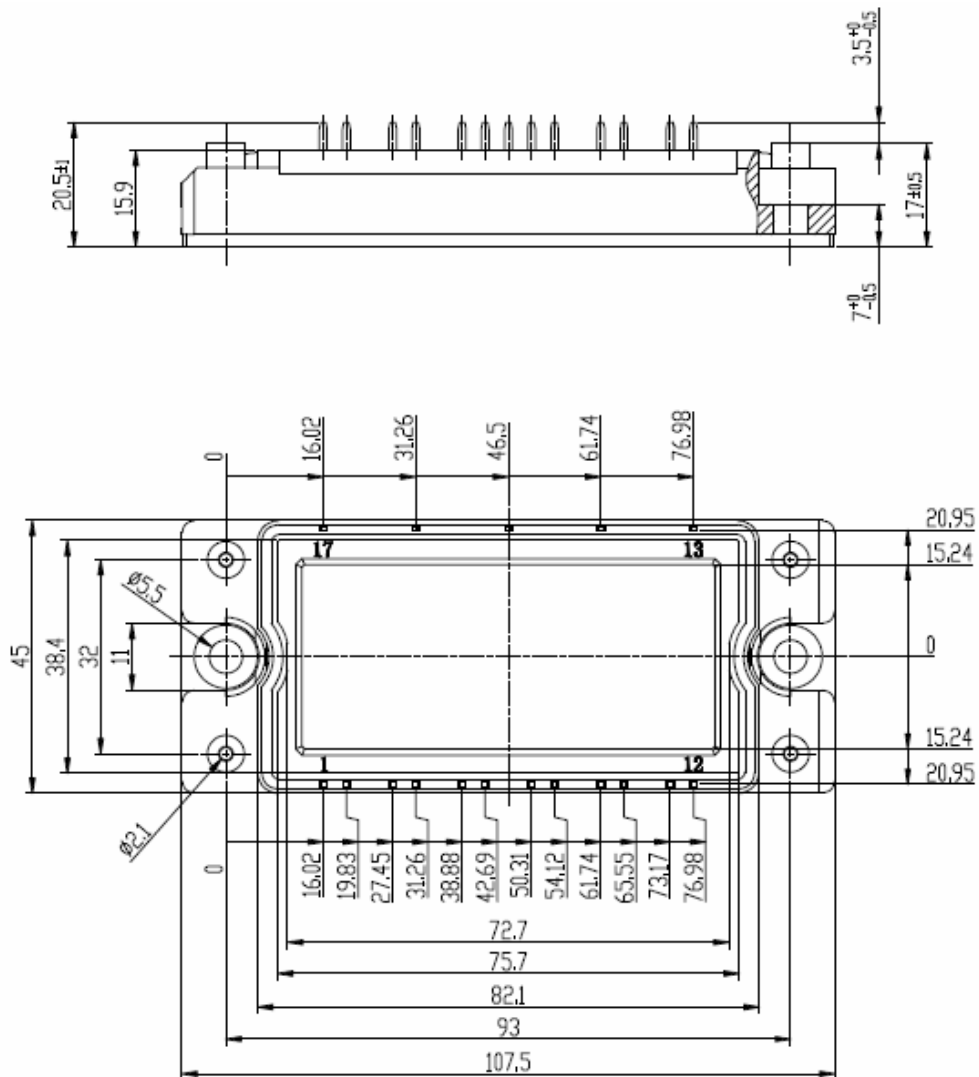
Equivalent Circuit Schematic



Pins 5,6,7,8,15 are not connected

Package Dimension

Dimensions in Millimeters



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